

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

**TC74HC540AP, TC74HC540AF, TC74HC540AFW**  
**TC74HC541AP, TC74HC541AF, TC74HC541AFW****OCTAL BUS BUFFER****TC74HC540AP / AF / AFW INVERTING, 3-STATE OUTPUTS****TC74HC541AP / AF / AFW NON-INVERTING, 3-STATE OUTPUTS**

(Note) The JEDEC SOP (FW) is not available in Japan.

The TC74HC540A/TC74HC541A are high speed CMOS OCTAL BUS BUFFERS fabricated with silicon gate C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

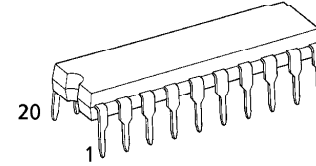
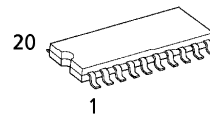
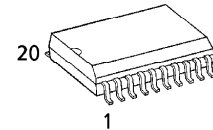
The TC74HC540A is a non-inverting type, and the TC74HC541A is an inverting type.

When either  $\bar{G}1$  or  $\bar{G}2$  are high, the terminal outputs are in the high-impedance state.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

**FEATURES:**

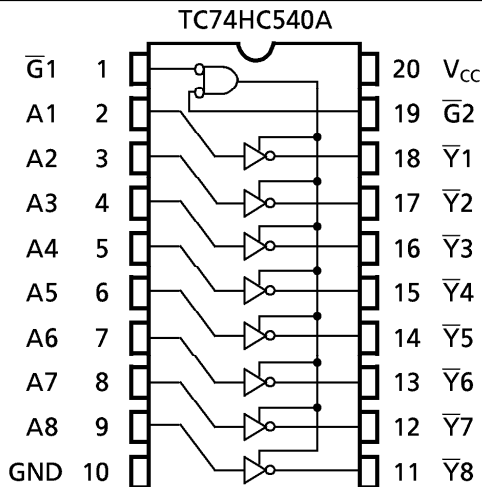
- High Speed..... $t_{pd} = 10\text{ns}(\text{typ.})$  at  $V_{CC} = 5\text{V}$
- Low Power Dissipation..... $I_{CC} = 4\mu\text{A}(\text{Max.})$  at  $T_a = 25^\circ\text{C}$
- High Noise Immunity..... $V_{NIH} = V_{NIL} = 28\% V_{CC}(\text{Min.})$
- Output Drive Capability..... 15 LSTTL Loads
- Symmetrical Output Impedance...  $|I_{OH}| = I_{OL} = 6\text{mA}(\text{Min.})$
- Balanced Propagation Delays..... $t_{PLH} \approx t_{PHL}$
- Wide Operating Voltage Range.....  $V_{CC}(\text{opr.}) = 2\text{V} \sim 6\text{V}$
- Pin and Function Compatible with 74LS540/541

P (DIP20-P-300-2.54A)  
Weight: 1.30g (Typ.)F (SOP20-P-300-1.27)  
Weight: 0.22g (Typ.)FW (SOL20-P-300-1.27)  
Weight: 0.46g (Typ.)**TRUTH TABLE**

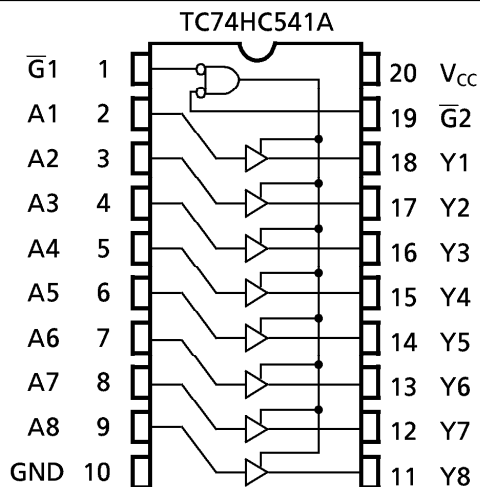
INPUTS			OUTPUTS	
$\bar{G}1$	$\bar{G}2$	$A_n$	$Y_n^*$	$\bar{Y}_n^*$
H	X	X	Z	Z
X	H	X	Z	Z
L	L	H	H	L
L	L	L	L	H

X : Don't Care

Z : High Impedance

\* :  $Y_n$  ..... HC541 $\bar{Y}_n$  ..... HC540**PIN ASSIGNMENT**

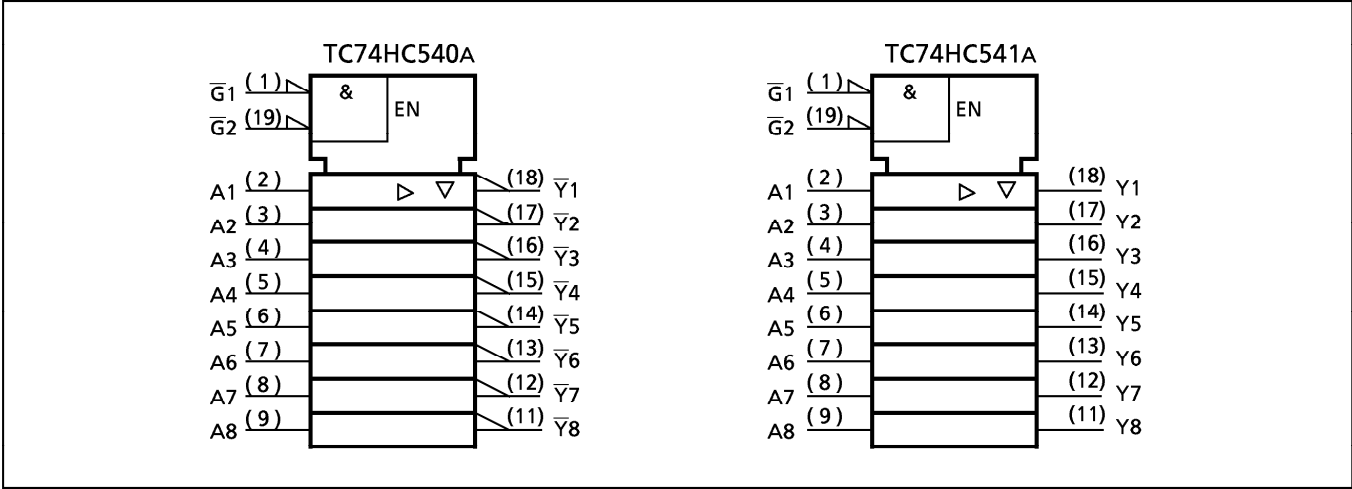
(TOP VIEW)



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IEC LOGIC SYMBOL



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## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	$V_{CC}$	$-0.5 \sim 7$	V
DC Input Voltage	$V_{IN}$	$-0.5 \sim V_{CC} + 0.5$	V
DC Output Voltage	$V_{OUT}$	$-0.5 \sim V_{CC} + 0.5$	V
Input Diode Current	$I_{IK}$	$\pm 20$	mA
Output Diode Current	$I_{OK}$	$\pm 20$	mA
DC Output Current	$I_{OUT}$	$\pm 35$	mA
DC $V_{CC}$ /Ground Current	$I_{CC}$	$\pm 75$	mA
Power Dissipation	$P_D$	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	$T_{stg}$	$-65 \sim 150$	$^{\circ}\text{C}$

\*500mW in the range of  $T_a = -40^{\circ}\text{C} \sim 65^{\circ}\text{C}$ . From  $T_a = 65^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  a derating factor of  $-10\text{mW}/^{\circ}\text{C}$  shall be applied until 300mW.

## RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	$V_{CC}$	$2 \sim 6$	V
Input Voltage	$V_{IN}$	$0 \sim V_{CC}$	V
Output Voltage	$V_{OUT}$	$0 \sim V_{CC}$	V
Operating Temperature	$T_{opr}$	$-40 \sim 85$	$^{\circ}\text{C}$
Input Rise and Fall Time	$t_r, t_f$	$0 \sim 1000 (V_{CC} = 2.0\text{V})$ $0 \sim 500 (V_{CC} = 4.5\text{V})$ $0 \sim 400 (V_{CC} = 6.0\text{V})$	ns

## DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	$V_{CC}$ (V)	$T_a = 25^{\circ}\text{C}$			$T_a = -40 \sim 85^{\circ}\text{C}$		UNIT
				MIN.	TYP.	MAX.	MIN.	MAX.	
High - Level Input Voltage	$V_{IH}$		2.0 4.5 6.0	1.50 3.15 4.20	— — —	— — —	1.50 3.15 4.20	— — —	V
Low - Level Input Voltage	$V_{IL}$		2.0 4.5 6.0	— — —	— — —	0.50 1.35 1.80	— — —	0.50 1.35 1.80	V
High - Level Output Voltage	$V_{OH}$	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20\mu\text{A}$	2.0 4.5 6.0	1.9 4.4 5.9	2.0 4.5 6.0	— — —	1.9 4.4 5.9	V
			$I_{OH} = -6 \text{ mA}$ $I_{OH} = -7.8 \text{ mA}$	4.5 6.0	4.18 5.68	4.31 5.80	— —	4.13 5.63	
Low - Level Output Voltage	$V_{OL}$	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20\mu\text{A}$	2.0 4.5 6.0	— — —	0.0 0.0 0.0	0.1 0.1 0.1	— — —	V
			$I_{OL} = 6 \text{ mA}$ $I_{OL} = 7.8 \text{ mA}$	4.5 6.0	— —	0.17 0.18	0.26 0.26	— —	
3 - State Output Off - State Current	$I_{OZ}$	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$	6.0	—	—	$\pm 0.5$	—	$\pm 5.0$	$\mu\text{A}$
Input Leakage Current	$I_{IN}$	$V_{IN} = V_{CC} \text{ or GND}$	6.0	—	—	$\pm 0.1$	—	$\pm 1.0$	
Quiescent Supply Current	$I_{CC}$	$V_{IN} = V_{CC} \text{ or GND}$	6.0	—	—	4.0	—	40.0	

AC ELECTRICAL CHARACTERISTICS ( Input  $t_r = t_f = 6\text{ns}$  )

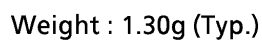
PARAMETER	SYMBOL	TEST CONDITION	CL (pF)	V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40~85°C		UNIT
					MIN.	TYP.	MAX.	MIN.	MAX.	
Output Transition Time	t <sub>TLH</sub> t <sub>THL</sub>		50	2.0 4.5 6.0	— — —	25 7 6	60 12 10	— — —	75 15 13	ns
Propagation Delay Time	t <sub>PLH</sub>	R <sub>L</sub> = 1kΩ	50	2.0	—	36	90	—	115	
				4.5	—	12	18	—	23	
	t <sub>PHL</sub>		50	6.0	—	10	15	—	20	
				2.0	—	51	130	—	165	
Output Enable Time	t <sub>pZL</sub>		50	4.5	—	14	25	—	31	
				6.0	—	12	21	—	26	
	t <sub>pZH</sub>		150	2.0	—	60	165	—	205	
				4.5	—	19	33	—	41	
Output Disable time	t <sub>pLZ</sub> t <sub>pHZ</sub>		50	6.0	—	16	28	—	35	
				2.0	—	40	125	—	155	
Input Capacitance	C <sub>IN</sub>				—	5	10	—	10	pF
Output Capacitance	C <sub>OUT</sub>				—	10	—	—	—	
Power Dissipation Capacitance	C <sub>PD</sub> (1)	TC74HC540A			—	32	—	—	—	
		TC74HC541A			—	35	—	—	—	

Note (1) C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

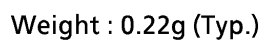
Average operating current can be obtained by the equation :

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

## Unit in mm



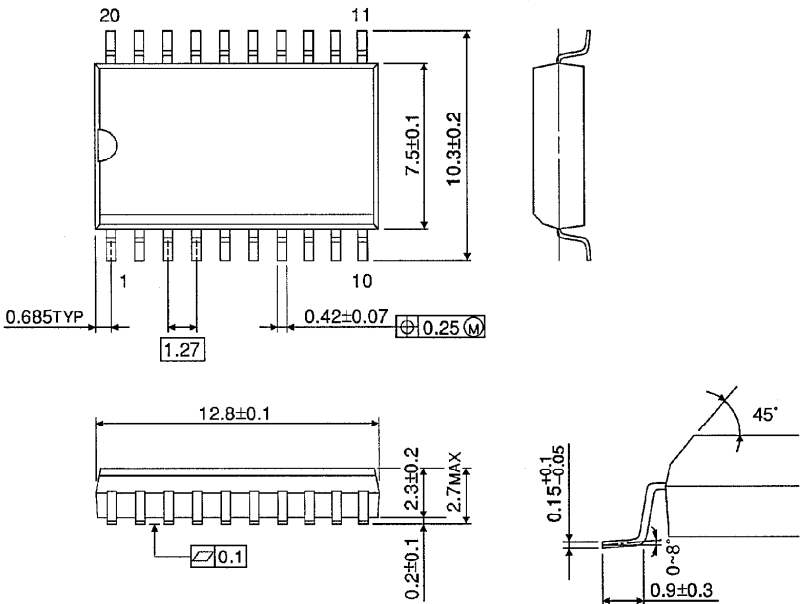
## Unit in mm



SOP 20PIN (300mil BODY) OUTLINE DRAWING (SOL20-P-300-1.27)

Unit in mm

(Note) This package is not available in Japan.



Weight : 0.46g (Typ.)